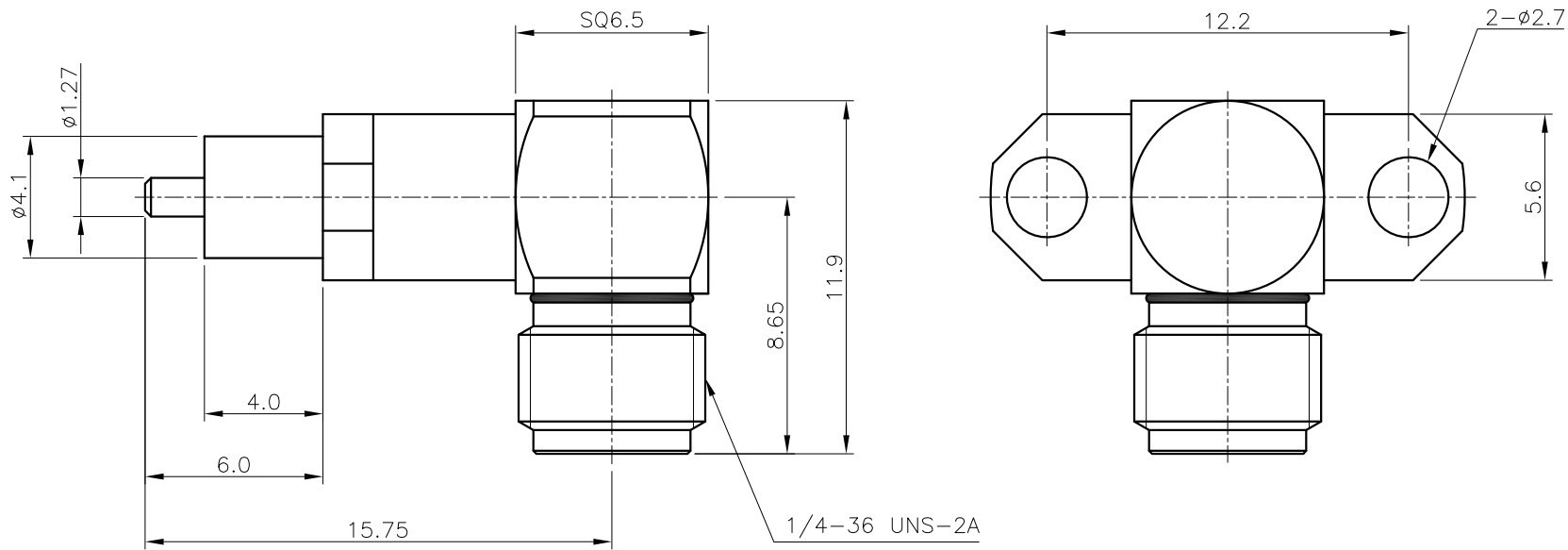


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.01.11.
1	[절면처리No.202203-0007] 절연체 초립시 burr 발생 BDOY 절연체 초립 초입부 면취 추가 및 공차 상한치 관리	S.H.KIM		2022.03.14.
2	은땀 구조 변경 (은납링 적용)	S.H.KIM		2024.01.24.



6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00042-5/3
5	INSULATOR	1	TEFLON		DIN01238-N/2
4	INSULATOR	1	TEFLON		DIN03025-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03671-5/2
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00151-5/2
1	1-2 BODY(B)	1	MBsBD C3604BD-F	Nickel Plate	DBD00206-1/1
	1-1 BODY(A)	1	MBsBD C3604BD-F		DBD00223-1/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 01. 24.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY					
MATERIAL _____		CHECKED BY			TITLE SMA50 SOLDER END JL-2H		
		DRAWN BY S.H.KIM					
FINISH _____		SCALE 4/1	UNIT mm		A4	DWG NO. CN03812-7/1	
						REVISION 2	SHEET 1 of 1